

ISL78233, ISL78234

3A and 4A Compact Synchronous Buck Regulators

FN8359 Rev.9.00 Feb 21, 2019

The ISL78233 and ISL78234 are highly efficient, monolithic, synchronous step-down DC/DC converters that can deliver 3A (ISL78233), or 4A (ISL78234) of continuous output current from a 2.7V to 5.5V input supply. The devices use current mode control architecture to deliver a very low duty cycle operation at high frequency with fast transient response and excellent loop stability.

The ISL78233 and ISL78234 integrate a very low ON-resistance P-channel (35m Ω) high-side FET and N-channel (11m Ω) low-side FET to maximize efficiency and minimize external component count. The 100% duty-cycle operation allows less than 200mV dropout voltage at 4A output current. The operation frequency of the Pulse-Width Modulator (PWM) is adjustable from 500kHz to 4MHz. The default switching frequency of 2MHz is set by connecting the FS pin high.

The ISL78233 and ISL78234 can be configured for discontinuous or forced continuous operation at light load. Forced continuous operation reduces noise and RF interference, while discontinuous mode provides higher efficiency by reducing switching losses at light loads.

Fault protection is provided by internal Hiccup mode current limiting during short-circuit and overcurrent conditions. Other protection, such as overvoltage and over-temperature are also integrated into the device. A power-good output voltage monitor indicates when the output is in regulation.

The ISL78233 and ISL78234 offer a 1ms Power-Good (PG) timer at power-up. When in shutdown, the ISL78233 and ISL78234 discharge the output capacitor through an internal soft-stop switch. Other features include internal fixed or adjustable soft-start and internal/external compensation.

The ISL78233 and ISL78234 are available in a 3mmx3mm 16 Ld Thin Quad Flat (TQFN) Pb-free package and in a 5mmx5mm 16 Ld Wettable Flank Quad Flat No-Lead (WFQFN) package with an exposed pad for improved thermal performance. The ISL78233 and ISL78234 are rated to operate across the temperature range of -40°C to +125°C.

Features

- 2.7V to 5.5V input voltage range
- Very low ON-resistance FETs P-channel $35m\Omega$ and N-channel $11m\Omega$ typical values
- High efficiency synchronous buck regulator with up to 95% efficiency
- -1.2%/1% reference accuracy over temperature/load/line
- · Complete BOM with as few as 3 external parts
- · Internal soft-start 1ms or adjustable
- · Soft-stop output discharge during disable
- Adjustable frequency from 500kHz to 4MHz default at 2MHz
- · External synchronization up to 4MHz
- Over-temperature, overcurrent, overvoltage, and negative overcurrent protection
- Shared common device pinout allows simplified output power upgrades over time
- Tiny 3mmx3mm TQFN package
- AEC-Q100 qualified

Applications

- DC/DC POL modules
- μ C/ μ P, FPGA, and DSP power
- Video processor/SOC power
- · Li-ion battery powered devices
- · Automotive infotainment power

Related Literature

For a full list of related documents, visit our website:

• ISL78233, ISL78234 device pages

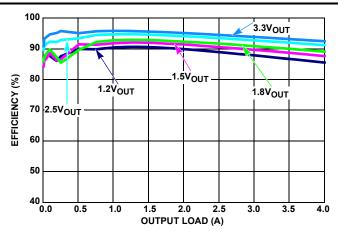


FIGURE 1. EFFICIENCY vs LOAD (2MHz 5VIN PFM, TA = +25°C)

Typical Application Diagram

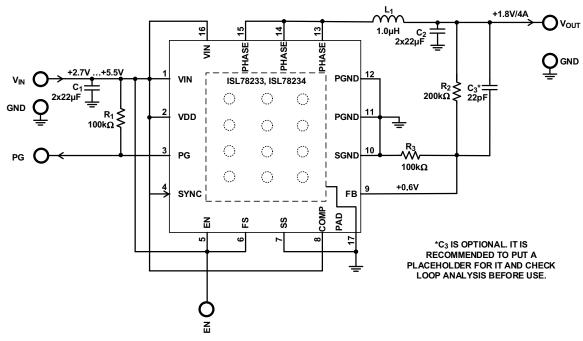


FIGURE 2. TYPICAL APPLICATION DIAGRAM

TABLE 1. COMPONENT SELECTION TABLE

V _{OUT}	1.2V	1.5V	1.8V	2.5V	3.3V	3.6V
C ₁	2 x 22µF	2 x 22µF	2 x 22µF	2 x 22µF	2 x 22μF	2 x 22µF
C ₂	2 x 22µF					
c ₃	22pF	22pF	22pF	22pF	22pF	22pF
L ₁	0.33-0.68µH	0.33-0.68µH	0.33-0.68µH	0.47-0.78µH	0.47-0.78µH	0.47-0.78µH
R ₂	100kΩ	150kΩ	200kΩ	316kΩ	450kΩ	500kΩ
R ₃	100kΩ	100kΩ	100kΩ	100kΩ	100kΩ	100kΩ

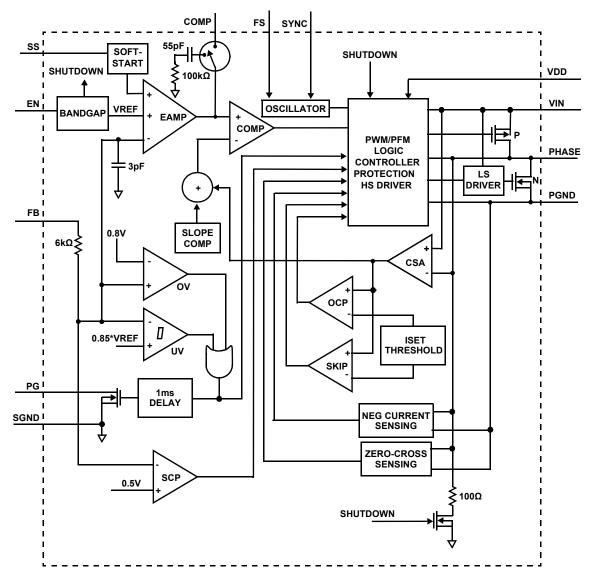


FIGURE 3. FUNCTIONAL BLOCK DIAGRAM

Ordering Information

PART NUMBER (Note 4)	PART MARKING	OUTPUT VOLTAGE (V)	TEMP. RANGE (°C)	TAPE AND REEL (UNITS) (Note 1)	PACKAGE (RoHS Compliant)	PKG. DWG. #
ISL78233ARZ (Note 2)	8233	Adjustable	-40 to +125	-	16 Ld 3x3 TQFN	L16.3x3D
ISL78233ARZ-T (Note 2)	8233	Adjustable	-40 to +125	6k	16 Ld 3x3 TQFN	L16.3x3D
ISL78233ARZ-T7A (Note 2)	8233	Adjustable	-40 to +125	250	16 Ld 3x3 TQFN	L16.3x3D
ISL78233AARZ (<u>Note 3</u>)	78233A ARZ	Adjustable	-40 to +125	-	16 Ld 5x5mm WFQFN	L16.5x5D
ISL78233AARZ-T (Note 3)	78233A ARZ	Adjustable	-40 to +125	6k	16 Ld 5x5mm WFQFN	L16.5x5D
ISL78233AARZ-T7A (Note 3)	78233A ARZ	Adjustable	-40 to +125	250	16 Ld 5x5mm WFQFN	L16.5x5D
ISL78234ARZ (Note 2)	8234	Adjustable	-40 to +125	-	16 Ld 3x3 TQFN	L16.3x3D
ISL78234ARZ-T (Note 2)	8234	Adjustable	-40 to +125	6k	16 Ld 3x3 TQFN	L16.3x3D
ISL78234ARZ-T7A (Note 2)	8234	Adjustable	-40 to +125	250	16 Ld 3x3 TQFN	L16.3x3D
ISL78234AARZ (<u>Note 3</u>)	78234A ARZ	Adjustable	-40 to +125	-	16 Ld 5x5mm WFQFN	L16.5x5D



Ordering Information

PART NUMBER (Note 4)	PART MARKING	OUTPUT VOLTAGE (V)	TEMP. RANGE (°C)	TAPE AND REEL (UNITS) (Note 1)	PACKAGE (RoHS Compliant)	PKG. DWG. #	
ISL78234AARZ-T (Note 3)	78234A ARZ	Adjustable	-40 to +125	6k	16 Ld 5x5mm WFQFN	L16.5x5D	
ISL78234AARZ-T7A (Note 3)	78234A ARZ	Adjustable	-40 to +125	250	16 Ld 5x5mm WFQFN	L16.5x5D	
ISL78233EVAL1Z	3x3mm TQFN Evaluation Board						
ISL78234EVAL1Z	3x3mm TQFN Evalua	3x3mm TQFN Evaluation Board					
ISL78233EVAL2Z	5x5mm WFQFN Eval	5x5mm WFQFN Evaluation Board					
ISL78234EVAL2Z	5x5mm WFQFN Eval	5x5mm WFQFN Evaluation Board					

NOTES:

- 1. See TB347 for details about reel specifications.
- These Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate
 plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Pb-free products are
 MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
- 3. These Pb-free plastic packaged products employ special Pb-free material sets; molding compounds/die attach materials and NiPdAu-Ag plate e4 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
- 4. For Moisture Sensitivity Level (MSL), see the ISL78233, ISL78234 device information pages. For more information about MSL, see TB363.

 PART NUMBER
 IOUT MAX (A)

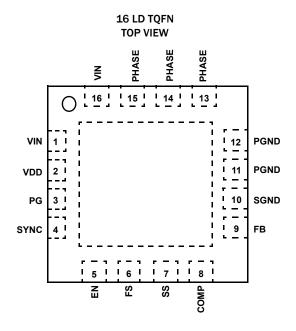
 ISL78233
 3

 ISL78234
 4

 ISL78235
 5

TABLE 2. KEY DIFFERENCE BETWEEN FAMILY OF PARTS

Pin Configuration





Pin Descriptions

PIN NUMBER	SYMBOL	DESCRIPTION
1, 16	VIN	Input supply voltage. Place a minimum of two $22\mu F$ ceramic capacitors from VIN to PGND as close as possible to the IC for decoupling.
2	VDD	Input supply voltage for logic. Connect to the VIN pin.
3	PG	Power-good is an open-drain output. Use a $10k\Omega$ to $100k\Omega$ pull-up resistor connected between VIN and PG. At power-up or EN HI, PG rising edge is delayed by 1ms upon output reached within regulation.
4	SYNC	Mode Selection pin. Connect to logic high or input voltage VIN for PWM mode. Connect to logic low or ground for PFM mode. Connect to an external function generator for synchronization with the positive edge trigger. There is an internal $1M\Omega$ pull-down resistor to prevent an undefined logic state in case of SYNC pin float.
5	EN	Regulator enable pin. Enable the output when driven to high. Shutdown the chip and discharge output capacitor when driven to low.
6	FS	This pin sets the oscillator switching frequency, using a resistor, RFS, from the FS pin to GND. The frequency of operation may be programmed between 500kHz to 4MHz. The default frequency is 2MHz if FS is connected to VIN.
7	SS	SS is used to adjust the soft-start time. Set to SGND for internal 1ms rise time. Connect a capacitor from SS to SGND to adjust the soft-start time. Do not use more than 33nF per IC.
8	COMP	The feedback network of the regulator, FB, is the negative input to the transconductance error
9	FB	amplifier. COMP is the output of the amplifier if COMP is not tied to VDD. Otherwise, COMP is disconnected through a MOSFET for internal compensation. Must connect COMP to VDD in internal compensation mode. The output voltage is set by an external resistor divider connected to FB. With a properly selected divider, the output voltage can be set to any voltage between the power rail (reduced by converter losses) and the 0.6V reference. There is an internal compensation to meet a typical application. Additional external networks across COMP and SGND might be required to improve the loop compensation of the amplifier operation. In addition, the regulator power-good and undervoltage protection circuitry use FB to monitor the regulator output voltage.
10	SGND	Signal ground
11, 12	PGND	Power ground
13, 14, 15	PHASE	Switching node connections. Connect to one terminal of the inductor. This pin is discharged by a 100Ω resistor when the device is disabled. See <u>"Functional Block Diagram" on page 3</u> for more detail.
Exposed Pad	-	The exposed pad must be connected to the SGND pin for proper electrical performance. Place as many vias as possible under the pad connecting to the SGND plane for optimal thermal performance.



Absolute Maximum Ratings (Reference to GND)

VIN0.3V to 5.8V (DC) or 7V (20ms)
EN, FS, PG, SYNC, VFB0.3V to VIN + 0.3V
PHASE
DC:0.3V to 6.5V
Pulsed (Note 8):2V (< 0.6μJ) to 7V (20ms)
COMP, SS (Note 7)0.3V to 2.7V
ESD Rating
Human Body Model (Tested per AEC-Q100-002) 5kV
Machine Model (Tested per AEC-Q100-003) 300V
Charge Device Model (Tested per AEC-Q100-011)2kV
Latch-Up (Tested per AEC-Q100-004, Class II, Level A) 100mA

Thermal Information

Thermal Resistance	θ_{JA} (°C/W)	θ _{JC} (°C/W)
16 Ld TQFN Package (Notes 5, 6)	43	3.5
16 Ld WFQFN Package (Notes 5, 6)	33	3.5
Operating Junction Temperature Range	5	5°C to +125°C
Storage Temperature Range	6	5°C to +150°C
Pb-Free Reflow Profile		see <u>TB493</u>

Recommended Operating Conditions

V _{IN} Supply Voltage Range	7V to 5.5V
(ISL78233)	. 0A to 3A
(ISL78234)	. 0A to 4A
Ambient Temperature Range40°C t	o +125°C

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions can adversely impact product reliability and result in failures not covered by warranty.

NOTES:

- 5. θ_{JA} is measured in free air with the component mounted on a high-effective thermal conductivity test board with "direct attach" features. See <u>18379</u>.
- 6. θ_{JC} , "case temperature" location is at the center of the exposed metal pad on the package underside.
- 7. COMP is an input and output pin. When the ISL7823x is used with an internal compensation, the COMP pin has a rating similar to VIN. When using the ISL7823x in an external compensation, the ratings are -0.3V to 2.7V.
- 8. The PHASE pin negative voltage can be less than -2V as long as the energy of the pulse does not exceed 0.6µJ.

Electrical Specifications Unless otherwise noted, all parameter limits are established across the recommended operating conditions and the specification limits are measured at the following conditions: $T_A = -40^{\circ}$ C to $+125^{\circ}$ C, $V_{IN} = 3.6$ V, $EN = V_{IN}$, unless otherwise noted. Typical values are at $T_A = +25^{\circ}$ C. Boldface limits apply across the operating temperature range, -40° C to $+125^{\circ}$ C.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note 9)	TYP	MAX (Note 9)	UNIT
INPUT SUPPLY	<u>'</u>		<u>'</u>		"	
V _{IN} Undervoltage Lockout Threshold	V _{UVLO}	Rising, no load		2.5	2.7	V
		Falling, no load	2.2	2.45		V
Quiescent Supply Current	I _{VIN}	SYNC = GND, no load at the output		45		μΑ
		SYNC = GND, no load at the output and no switches switching		45	60	μΑ
		SYNC = V _{IN} , FS = 2MHz, no load at the output		19	25	mA
Shutdown Supply Current	I _{SD}	SYNC = GND, V _{IN} = 5.5V, EN = low		3.8	10	μΑ
OUTPUT REGULATION			-		1	
Reference Voltage	V _{REF}		0.593	0.600	0.606	V
VFB Bias Current	I _{VFB}	VFB = 0.75V		0.1		μΑ
Line Regulation		$V_{IN} = V_0 + 0.5V \text{ to } 5.5V \text{ (minimal } 2.7V)$		0.2		%/V
Soft-Start Ramp Time Cycle		SS = SGND		1		ms
Soft-Start Charging Current	I _{SS}	V _{SS} = 0.1V	1.7	2.1	2.5	μΑ
OVERCURRENT PROTECTION			<u>.</u>			
Current Limit Blanking Time	tocon			17		Clock pulses
Overcurrent and Auto Restart Period	tocoff			8		SS cycle
Positive Peak Current Limit	I _{PLIMIT}	ISL78234, T _A = +25°C	5.4	6.7	8.1	Α
		ISL78234, T _A = -40°C to +125°C	5.2		9	Α
		ISL78233, T _A = +25°C	3.9	4.9	6	Α
		ISL78233, T _A = -40°C to +125°C	3.7		6.6	Α



Electrical Specifications Unless otherwise noted, all parameter limits are established across the recommended operating conditions and the specification limits are measured at the following conditions: $T_A = -40 \,^{\circ}\text{C}$ to $+125 \,^{\circ}\text{C}$, $V_{IN} = 3.6\text{V}$, $EN = V_{IN}$, unless otherwise noted. Typical values are at $T_A = +25 \,^{\circ}\text{C}$. Boldface limits apply across the operating temperature range, $-40 \,^{\circ}\text{C}$ to $+125 \,^{\circ}\text{C}$. (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (<u>Note 9</u>)	TYP	MAX (<u>Note 9</u>)	UNIT
Peak Skip Limit	I _{SKIP}	ISL78234, T _A = +25°C	0.9	1.1	1.35	Α
		ISL78234, T _A = -40°C to +125°C	0.84		1.5	Α
		ISL78233, T _A = +25°C	0.7	0.9	1.2	Α
		ISL78233, T _A = -40°C to +125°C	0.6		1.3	Α
Zero Cross Threshold			-275		375	mA
Negative Current Limit	I _{NLIMIT}	T _A = +25°C	-5.1	-2.8	-1.3	Α
		T _A = -40°C to +125°C	-6.0		-0.6	Α
COMPENSATION			<u>, </u>			
Error Amplifier Transconductance		COMP = V _{DD} , internal compensation		125		μ A /V
		External compensation		130		μA/V
Transresistance	RT	4A application	0.145	0.2	0.25	Ω
PHASE			1			
P-Channel MOSFET ON-Resistance		V _{IN} = 5V, I _O = 200mA	26	35	50	mΩ
		V _{IN} = 2.7V, I _O = 200mA	38	52	78	mΩ
N-Channel MOSFET ON-Resistance		V _{IN} = 5V, I _O = 200mA	5	11	20	mΩ
		V _{IN} = 2.7V, I ₀ = 200mA	8	15	31	mΩ
PHASE Maximum Duty Cycle				100		%
PHASE Minimum On-Time		SYNC = High			100	ns
OSCILLATOR			1		1	
Nominal Switching Frequency	f _{SW}	FS = V _{IN}	1700	2000	2350	kHz
		FS with RS = 402kΩ		420		kHz
		FS with RS = 42.2kΩ		4200		kHz
SYNC Logic LOW to HIGH Transition Range			0.67	0.75	0.84	٧
SYNC Hysteresis				0.17		٧
SYNC Logic Input Leakage Current		V _{IN} = 3.6V		3.7	5	μA
PG			1		1	
Output Low Voltage		IPG = 1mA			0.3	٧
Delay Time (Rising Edge)		Time from V _{OUT} reached regulation	0.5	1	2	ms
PG Pin Leakage Current		PG = V _{IN}		0.01	0.1	μΑ
OVP PG Rising Threshold				0.80		٧
UVP PG Rising Threshold			80	86	90	%
UVP PG Hysteresis				5.5		%
PGOOD Delay Time (Falling Edge)				6.5		μs
EN	<u> </u>				1	
Logic Input Low (<u>Note 10</u>)	EN_VIL				0.4	٧
Logic Input High	EN_VIH		0.9			V
EN Logic Input Leakage Current		Pulled up to 3.6V		0.1	1	μA
Thermal Shutdown		Temperature Rising		150		°C
Thermal Shutdown Hysteresis	1	Temperature Falling		25		°C

NOTE:

- 9. Compliance to datasheet limits is assured by one or more methods: production test, characterization and/or design.
- 10. EN should be held below the EN_VIL until $V_{\mbox{\footnotesize{IN}}}$ exceeds $V_{\mbox{\footnotesize{UVLO}}}$ rising.



Typical Operating Performance Unless otherwise noted, operating conditions are: T_A = +25°C, V_{IN} = 5V, EN = V_{IN},

SYNC = V_{IN} , L = 1.0 μ H, C_1 = 22 μ F, C_2 = 2 x 22 μ F, I_{OUT} = 0A to 4A.

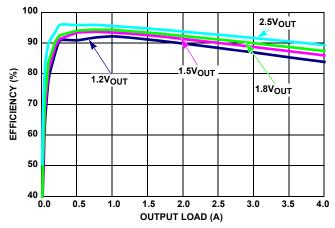


FIGURE 4. EFFICIENCY vs LOAD (2MHz, 3.3VIN PWM)

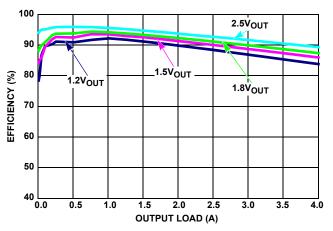


FIGURE 5. EFFICIENCY vs LOAD (2MHz, 3.3V_{IN} PFM)

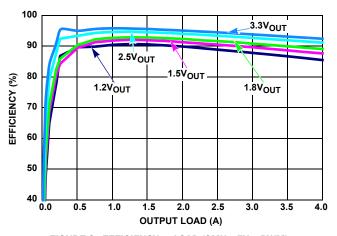


FIGURE 6. EFFICIENCY vs LOAD (2MHz, 5VIN PWM)

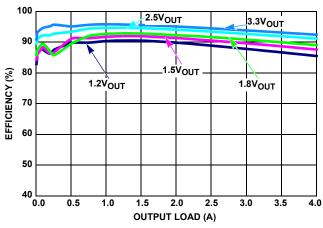


FIGURE 7. EFFICIENCY vs LOAD (2MHz, 5VIN PFM)

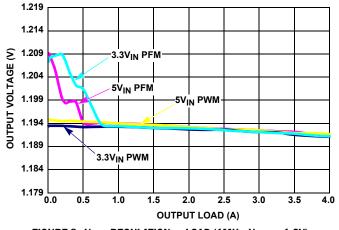


FIGURE 8. V_{OUT} REGULATION vs LOAD (1MHz, V_{OUT} = 1.2V)

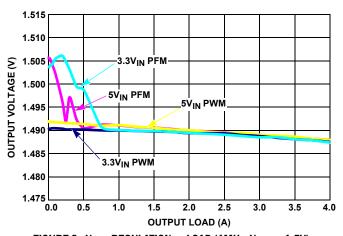


FIGURE 9. V_{OUT} REGULATION vs LOAD (1MHz, V_{OUT} = 1.5V)

Typical Operating Performance Unless otherwise noted, operating conditions are: $T_A = +25 \,^{\circ}$ C, $V_{IN} = 5V$, EN = V_{IN} , SYNC = V_{IN} , L = 1.0 μ H, $C_1 = 22\mu$ F, $C_2 = 2 \times 22\mu$ F, $I_{OUT} = 0$ A to 4A. (**Continued**)

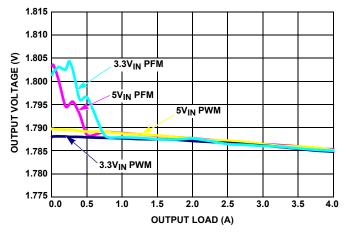


FIGURE 10. V_{OUT} REGULATION vs LOAD (1MHz, V_{OUT} = 1.8V)

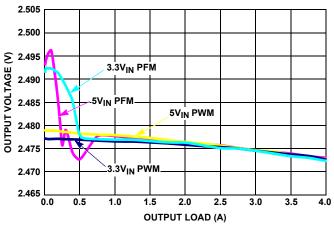


FIGURE 11. V_{OUT} REGULATION vs LOAD (1MHz, $V_{OUT} = 2.5V$)

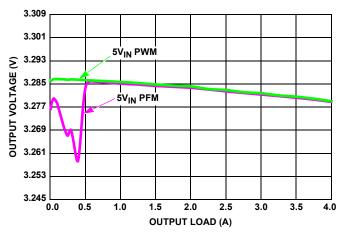


FIGURE 12. V_{OUT} REGULATION vs LOAD (1MHz, V_{OUT} = 3.3V)

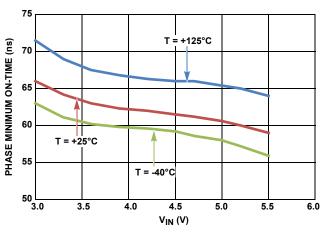


FIGURE 13. PHASE MINIMUM ON-TIME vs V_{IN} (2MHz)

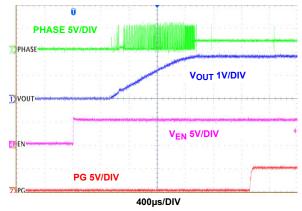


FIGURE 14. START-UP AT NO LOAD (PFM)

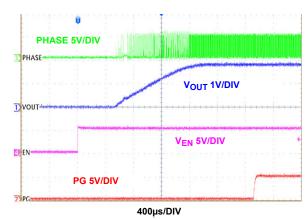


FIGURE 15. START-UP AT NO LOAD (PWM)

Typical Operating Performance Unless otherwise noted, operating conditions are: $T_A = +25 \,^{\circ}$ C, $V_{IN} = 5$ V, EN = V_{IN} , SYNC = V_{IN} , L = 1.0 μ H, $C_1 = 22 \mu$ F, $C_2 = 2 \times 22 \mu$ F, $I_{OUT} = 0$ A to 4A. (Continued)

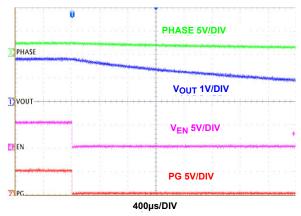


FIGURE 16. SHUTDOWN AT NO LOAD (PFM)

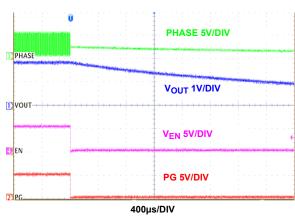


FIGURE 17. SHUTDOWN AT NO LOAD (PWM)

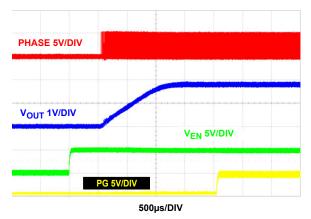


FIGURE 18. START-UP AT 4A LOAD (PWM)

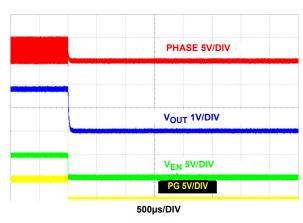


FIGURE 19. SHUTDOWN AT 4A LOAD (PWM)

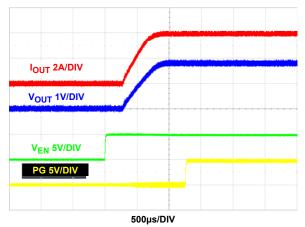


FIGURE 20. START-UP AT 4A LOAD (PFM)

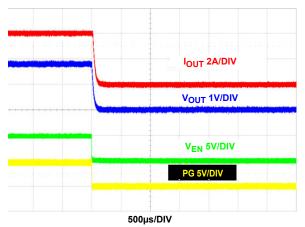


FIGURE 21. SHUTDOWN AT 4A LOAD (PFM)

Typical Operating Performance Unless otherwise noted, operating conditions are: $T_A = +25$ °C, $V_{IN} = 5V$, EN = V_{IN} , SYNC = V_{IN} , L = 1.0 μ H, C₁ = 22 μ F, C₂ = 2 x 22 μ F, I_{OUT} = 0A to 4A. (**Continued**)

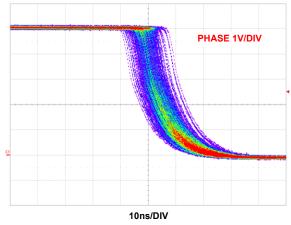


FIGURE 22. JITTER AT NO LOAD PWM (1MHz)

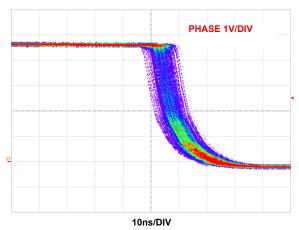


FIGURE 23. JITTER AT FULL LOAD PWM (1MHz)

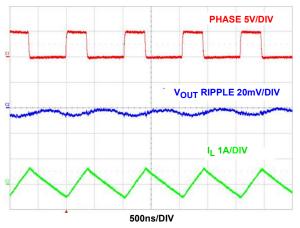


FIGURE 24. STEADY STATE AT NO LOAD PWM

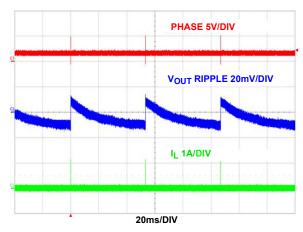


FIGURE 25. STEADY STATE AT NO LOAD PFM

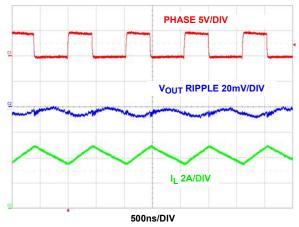


FIGURE 26. STEADY STATE AT 4A PWM

Typical Operating Performance Unless otherwise noted, operating conditions are: $T_A = +25$ °C, $V_{IN} = 5V$, EN = V_{IN} , SYNC = V_{IN} , L = 1.0 μ H, C₁ = 22 μ F, C₂ = 2 x 22 μ F, I_{OUT} = 0A to 4A. (**Continued**)

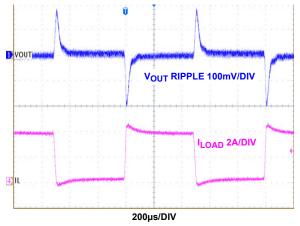


FIGURE 27. LOAD TRANSIENTS (PWM)

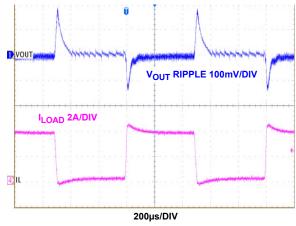


FIGURE 28. LOAD TRANSIENTS (PFM)

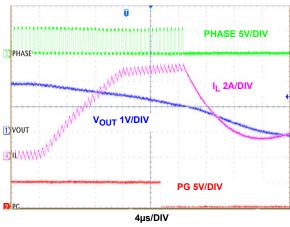


FIGURE 29. OUTPUT SHORT-CIRCUIT

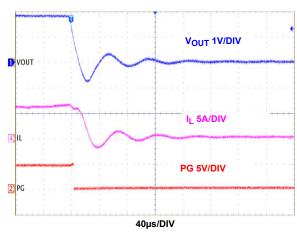


FIGURE 30. OVERCURRENT PROTECTION

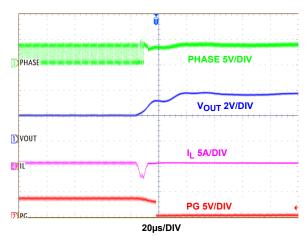


FIGURE 31. OVERVOLTAGE PROTECTION

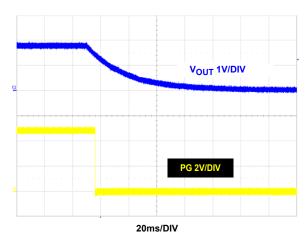


FIGURE 32. OVER-TEMPERATURE PROTECTION

Theory of Operation

The ISL78233 and ISL78234 are step-down switching regulators optimized for automotive battery powered applications. The regulator operates at a 2MHz default switching frequency for high efficiency and allow smaller form factor, when FS is connected to VIN. By connecting a resistor from FS to SGND, the operational frequency adjustable range is 500kHz to 4MHz. At light load, the regulator reduces the switching frequency, unless forced to the fixed frequency, to minimize the switching loss and to maximize the battery life. The quiescent current when the output is not loaded is typically only 45µA. The supply current is typically only 3.8µA when the regulator is shut down.

PWM Control Scheme

Pulling the SYNC pin HI (>0.8V) forces the converter into PWM mode, regardless of output current. The ISL78233 and ISL78234 employ the current-mode Pulse-Width Modulation (PWM) control scheme for fast transient response and pulse-by-pulse current limiting. Figure 3 on page 3 shows the functional block diagram. The current loop consists of the oscillator, the PWM comparator, current-sensing circuit, and the slope compensation for the current loop stability. The slope compensation is 440mV/Ts, which changes proportionally with frequency. The gain for the current-sensing circuit is typically 200mV/A. The control reference for the current loops comes from the Error Amplifier's (EAMP) output.

The PWM operation is initialized by the clock from the oscillator. The P-channel MOSFET is turned on at the beginning of a PWM cycle and the current in the MOSFET starts to ramp up. When the sum of the current amplifier CSA and the slope compensation reaches the control reference of the current loop, the PWM comparator COMP sends a signal to the PWM logic to turn off the PFET and turn on the N-channel MOSFET. The NFET stays on until the end of the PWM cycle. Figure 33 shows the typical operating waveforms during the PWM operation. The dotted lines illustrate the sum of the slope compensation ramp and the current-sense amplifier's CSA output.

The output voltage is regulated by controlling the V_{EAMP} voltage to the current loop. The bandgap circuit outputs a 0.6V reference voltage to the voltage loop. The feedback signal comes from the VFB pin. The soft-start block only affects the operation during the start-up and is discussed separately. The error amplifier is a transconductance amplifier that converts the voltage error signal to a current output. The voltage loop is internally compensated with the 55 pF and $100 k\Omega$ RC network. The maximum EAMP voltage output is precisely clamped to 2.5V.

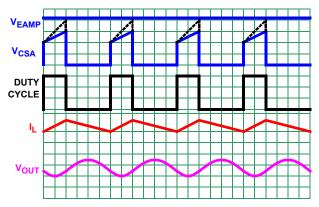


FIGURE 33. PWM OPERATION WAVEFORMS

Skip Mode

Pulling the SYNC pin LO (<0.4V) forces the converter into PFM mode. The ISL78233 and ISL78234 enter a Pulse-Skipping mode at light load to minimize the switching loss by reducing the switching frequency. Figure 34 on page 14 illustrates Skip mode operation. A zero-cross sensing circuit shown in Figure 3 on page 3 monitors the NFET current for zero crossing. When 16 consecutive cycles are detected, the regulator enters Skip mode. During the sixteen detecting cycles, the current in the inductor is allowed to become negative. The counter is reset to zero when the current in any cycle does not cross zero.

When Skip mode is entered, the pulse modulation starts being controlled by the Skip comparator shown in Figure 3 on page 3. Each pulse cycle is still synchronized by the PWM clock. The PFET is turned on at the clock's rising edge and turned off when the output is higher than 1.2% of the nominal regulation or when its current reaches the peak Skip current limit value. Then, the inductor current is discharging to OA and stays at zero (the internal clock is disabled), and the output voltage reduces gradually due to the load current discharging the output capacitor. When the output voltage drops to the nominal voltage, the PFET is turned on again at the rising edge of the internal clock as it repeats the previous operations.

The regulator resumes normal PWM mode operation when the output voltage drops 1.2% below the nominal voltage.

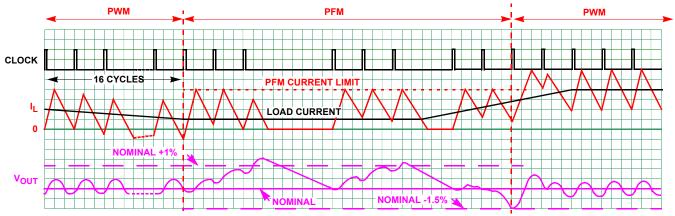


FIGURE 34. SKIP MODE OPERATION WAVEFORMS

Frequency Adjust

The frequency of operation is fixed at 2MHz when FS is tied to VIN. Adjustable frequency ranges from 500kHz to 4MHz using a simple resistor connecting FS to SGND according to Equation 1:

$$R_{FS}[k\Omega] = \frac{220 \cdot 10^3}{f_{OSC}[kHz]} - 14$$
 (EQ. 1)

The ISL78233 and ISL78234 have frequency synchronization capability by simply connecting the SYNC pin to an external square pulse waveform. The frequency synchronization feature synchronizes the positive edge trigger and its switching frequency up to 4MHz. The minimum external SYNC frequency is half of the free running frequency (either the default frequency or determined by the FS resistor).

Overcurrent Protection

The overcurrent protection is realized by monitoring the CSA output with the OCP comparator, as shown in Figure 3 on page 3. The current sensing circuit has a gain of 200mV/A, from the P-FET current to the CSA output. When the CSA output reaches the threshold, the OCP comparator is tripled to turn off the PFET immediately. The overcurrent function protects the switching converter from a shorted output by monitoring the current flowing through the upper MOSFET.

If an overcurrent condition is detected, the upper MOSFET is immediately turned off and does not turn on again until the next switching cycle. When the initial overcurrent condition is detected, the overcurrent fault counter is set to 1. If, on the subsequent cycle, another overcurrent condition is detected, the OC fault counter is incremented. If there are 17 sequential OC fault detections, the regulator is shut down under an overcurrent fault condition. An overcurrent fault condition results in the regulator attempting to restart in a Hiccup mode within the delay of eight soft-start periods. At the end of the eighth soft-start wait period, the fault counters are reset and soft-start is attempted again. If the overcurrent condition goes away during the delay of eight soft-start periods, the output resumes back into regulation point after Hiccup mode expires.

Negative Current Protection

Similar to overcurrent, the negative current protection is realized by monitoring the current across the low-side NFET, as shown in Figure 3 on page 3. When the valley point of the inductor current reaches -3A for four consecutive cycles, both PFET and NFET are off. The 100Ω in parallel to the NFET activates discharging the output into regulation. The control begins to switch when output is within regulation. The regulator is in PFM for 20μ s before switching to PWM if necessary.

PG

PG is an open-drain output of a window comparator that continuously monitors the buck regulator output voltage. PG is actively held low when EN is low and during the buck regulator soft-start period. After a 1ms soft-start period delay, PG becomes high impedance as long as the output voltage is within nominal regulation voltage set by VFB. When VFB drops 15% below or raises 0.8V above the nominal regulation voltage, the ISL78233 and ISL78234 pull PG low. Any fault condition forces PG low until the fault condition is cleared by attempts to soft-start. For logic level output voltages, connect an external pull-up resistor, $R_{\rm 1}$, between PG and VIN. A 100k Ω resistor works well in most applications.

UVLO

When the input voltage is below the Undervoltage Lockout (UVLO) threshold, the regulator is disabled.

Soft Start-Up

The soft start-up reduces the inrush current during the start-up. The soft-start block outputs a ramp reference to the input of the error amplifier. This voltage ramp limits the inductor current and the output voltage speed, so that the output voltage rises in a controlled fashion. When VFB is less than 0.1V at the beginning of the soft-start, the switching frequency is reduced to 200kHz so that the output can start-up smoothly at light load condition. During soft-start, the IC operates in Skip mode to support prebiased output condition.

Tie SS to SGND for internal soft-start is approximately 1ms. Connect a capacitor from SS to SGND to adjust the soft-start time. This capacitor, along with an internal 2.1 μ A current source



sets the soft-start interval of the converter, t_{SS} as shown by Equation 2.

$$C_{SS}[\mu F] = 3.1 \cdot t_{SS}[s] \tag{EQ. 2}$$

C_{SS} must be less than 33nF to insure proper soft-start reset after fault condition.

Enable

The Enable (EN) input allows you to control the turning on or off of the regulator for purposes such as power-up sequencing. When the regulator is enabled, there is typically a 600 μ s delay for waking up the bandgap reference and then the soft start-up begins. EN should be held below the EN_VIL until V_{IN} exceeds V_{UVLO} rising.

Discharge Mode (Soft-Stop)

When a transition to shutdown mode occurs or the V_{IN} UVLO is set, the outputs discharge to GND through an internal 100Ω switch.

Power MOSFETs

The power MOSFETs are optimized for best efficiency. The ON-resistance for the PFET is typically $35m\Omega$ and the ON-resistance for the NFET is typically $11m\Omega$.

100% Duty Cycle

The ISL78233 and ISL78234 feature 100% duty cycle operation to maximize the battery life. When the battery voltage drops to a level that the ISL78233 and ISL78234 can no longer maintain the regulation at the output, the regulator completely turns on the P-FET. The maximum dropout voltage under the 100% duty-cycle operation is the product of the load current and the ON-resistance of the PFET.

Thermal Shutdown

The ISL78233 and ISL78234 have built-in thermal protection. When the internal temperature reaches +150°C, the regulator is completely shut down. As the temperature drops to +125°C, the ISL78233 and ISL78234 resume operation by stepping through the soft-start.

Applications Information

Output Inductor and Capacitor Selection

To consider steady state and transient operations, the ISL78233 and ISL78234 typically use a 1.0µH output inductor. The higher or lower inductor value can be used to optimize the total converter system performance. For example, for higher output voltage 3.3V application, in order to decrease the inductor current ripple and output voltage ripple, the output inductor value can be increased. Renesas recommends setting the ripple inductor current to approximately 30% of the maximum output current for optimized performance. The inductor ripple current can be expressed as shown in Equation 3:

$$\Delta I = \frac{V_O \cdot \left(1 - \frac{V_O}{V_{IN}}\right)}{L \cdot f_S}$$
 (EQ. 3)

The inductor's saturation current rating needs to be at least larger than the peak current. The ISL78233 and ISL78234 protect the typical peak current 4.9A/6.7A. The saturation current needs to be over 7A for maximum output current application.

The ISL78233 and ISL78234 use an internal compensation network and the output capacitor value is dependent on the output voltage. The recommended ceramic capacitor is X5R or X7R. The recommended X5R or X7R minimum output capacitor values are shown in Table 1 on page 2.

In <u>Table 1</u>, the minimum output capacitor value is given for the different output voltages to make sure that the whole converter system is stable. Additional output capacitance should be added for better performance in applications where high load transient or low output ripple is required. Renesas recommends checking the system level performance along with the simulation model.

Output Voltage Selection

The output voltage of the regulator can be programmed using an external resistor divider that scales the output voltage relative to the internal reference voltage, and feeds it back to the inverting input of the error amplifier (see Figure 2 on page 2).

The output voltage programming resistor, R_2 , depends on the value chosen for the feedback resistor and the desired output voltage of the regulator. The value for the feedback resistor, R_3 , is typically between $10k\Omega$ and $100k\Omega$, as shown in Equation 4.

$$R_2 = R_3 \left(\frac{V_0}{VFB} - 1 \right)$$
 (EQ. 4)

If the output voltage desired is 0.6V, then R_3 is left unpopulated and R_2 is shorted. There is a leakage current from VIN to PHASE. Renesas recommends preloading the output with $10\mu A$ minimum. For better performance, add 15pF in parallel with R_2 (200k Ω). Check loop analysis before use in application.

Input Capacitor Selection

The main functions for the input capacitor are providing decoupling of the parasitic inductance and a filtering function to prevent the switching current flowing back to the battery rail. At least two 22µF X5R or X7R ceramic capacitors are a good starting point for the input capacitor selection.

Loop Compensation Design

When COMP is not connected to VDD, the COMP pin is active for external loop compensation. The ISL78233 and ISL78234 use constant frequency peak current mode control architecture to achieve a fast loop transient response. An accurate current-sensing pilot device in parallel with the upper MOSFET is used for peak current control signal and overcurrent protection. The inductor is not considered as a state variable because its peak current is constant, and the system becomes a single order system. It is much easier to design a type II compensator to stabilize the loop than to implement voltage mode control. Peak current mode control has an inherent input voltage feed-forward function to achieve good line regulation. Figure 35 on page 16 shows the small signal model of the synchronous buck regulator.



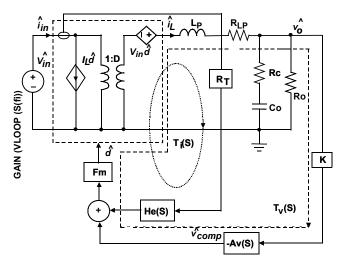


FIGURE 35. SMALL SIGNAL MODEL OF SYNCHRONOUS BUCK REGULATOR

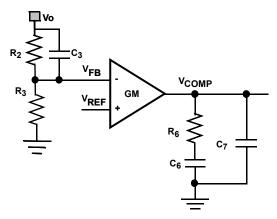


FIGURE 36. TYPE II COMPENSATOR

Figure 36 shows the type II compensator and its transfer function is expressed as Equation 5:

$$A_{v}(S) = \frac{\hat{v}_{comp}}{\hat{v}_{FB}} = \frac{GM \cdot R_{3}}{(C_{6} + C_{7}) \cdot (R_{2} + R_{3})} \cdot \frac{\left(1 + \frac{S}{\omega_{cz1}}\right)\left(1 + \frac{S}{\omega_{cz2}}\right)}{S\left(1 + \frac{S}{\omega_{cp1}}\right)\left(1 + \frac{S}{\omega_{cp2}}\right)}$$

where.

$$\omega_{\text{cz1}} = \frac{1}{R_6 C_6}, \ \omega_{\text{cz2}} = \frac{1}{R_2 C_3}, \\ \omega_{\text{cp1}} = \frac{C_6 + C_7}{R_6 C_6 C_7}, \\ \omega_{\text{cp2}} = \frac{R_2 + R_3}{C_3 R_2 R_3}$$

Compensator design goal:

- · High DC gain
- Choose loop bandwidth $\rm f_{\rm C}$ less than 100kHz
- Gain margin: >10dB
- Phase margin: >40°

The compensator design procedure is as follows:

The loop gain at crossover frequency of f_c has a unity gain. Therefore, the compensator resistance R_6 is determined by Equation 6.

$$R_{6} = \frac{2\pi f_{c} V_{o} C_{o} R_{t}}{GM \cdot V_{FB}} = 17.45 \times 10^{3} \cdot f_{c} V_{o} C_{o}$$
 (EQ. 6)

where GM is the sum of the transconductance, g_m , of the voltage error amplifier in each phase. Compensator capacitor C_6 is then given by Equation 7.

$$C_{6} = \frac{R_{o}C_{o}}{R_{6}} = \frac{V_{o}C_{o}}{I_{o}R_{6}}, C_{7} = max(\frac{R_{c}C_{o}}{R_{6}}, \frac{1}{\pi f_{s}R_{6}})$$
 (EQ. 7)

Place one compensator pole at zero frequency to achieve high DC gain, and put another compensator pole at either ESR zero frequency or half switching frequency, whichever is lower in Equation 7. An optional zero can boost the phase margin. Ω_{CZ2} is a zero due to R_2 and C_3 .

Place compensator zero 2 to 5 times f_c:

$$C_3 = \frac{1}{\pi f_c R_2}$$
 (EQ. 8)

Example: V_{IN} = 5V, V₀ = 1.8V, I₀ = 4A, FS = 1MHz, R₂ = 200k Ω , R₃ = 100k Ω , C₀ = 2x22 μ F/3m Ω , L = 1 μ H, f_c = 100kHz, then compensator resistance R₆:

$$R_6 = 17.45 \times 10^3 \cdot 100 \text{kHz} \cdot 1.8 \text{V} \cdot 44 \mu \text{F} = 138 \text{k}\Omega$$
 (EQ. 9)

It is acceptable to use 137k $\!\Omega$ as the closest standard value for Re.

$$C_6 = \frac{1.8 \text{V} \cdot 44 \mu \text{F}}{4 \text{A} \cdot 137 \text{k}\Omega} = 144 \text{pF}$$
 (EQ. 10)

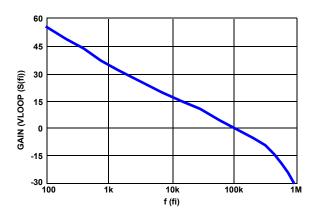
$$C_7 = max(\frac{3m\Omega \cdot 44\mu F}{137k\Omega}, \frac{1}{\pi \cdot 1MHz(137k\Omega)}) = (1pF, 2.3pF)$$
 (EQ. 11)

It is also acceptable to use the closest standard values for C_6 and C_7 . There is approximately 3pF parasitic capacitance from V_{COMP} to GND; Therefore, C_7 is optional. Use C_6 = 150pF and C_7 = OPEN.

$$C_3 = \frac{1}{\pi 100 \text{kHz} \cdot 200 \text{k}\Omega} = 16 \text{pF}$$
 (EQ. 12)

Use C_3 = 15pF. Note that C_3 may increase the loop bandwidth from previous estimated value. Figure 37 on page 17 shows the simulated voltage loop gain. It is shown that it has a 150kHz loop bandwidth with a 42° phase margin and 10dB gain margin. It may be more desirable to achieve an increased phase margin. This can be accomplished by lowering R_6 by 20% to 30%.





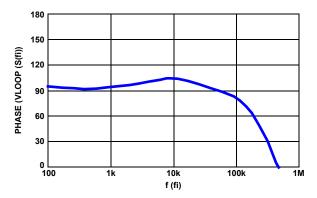


FIGURE 37. SIMULATED LOOP GAIN

PCB Layout Recommendation

The PCB layout is a very important converter design step to make sure the designed converter works well. For the ISL78233 and ISL78234, the power loop is composed of the output inductor L's, the output capacitor C_O, the PHASE pins, and the PGND pin. It is necessary to make the power loop as small as possible and the connecting traces among them should be direct, short, and wide. The switching node of the converter, the PHASE pins and the traces connected to the node are very noisy, so keep the voltage feedback trace away from these noisy traces. Place the input capacitor as close as possible to the VIN pin. Connect the ground of the input and output capacitors as close as possible. The heat of the IC is mainly dissipated through the thermal pad. Maximizing the copper area connected to the thermal pad is preferable. In addition, a solid ground plane is helpful for better EMI performance. See TB389 for via placement on the copper area of the PCB underneath the thermal pad for optimum thermal performance.

Revision History The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to web to make sure you have the latest revision.

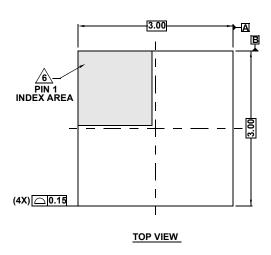
DATE	REVISION	CHANGE
Feb 21, 2019	FN8359.9	Updated PHASE Absolute Maximum Ratings information. Added Notes 7 and 8. Updated links throughout document. Updated disclaimer.
Apr 19, 2018	FN8359.8	Updated Related Literature section. Updated Ordering Information table by adding tape and reel information, Note 3, and updating Note 1. Adding Note 8 and its cross-referencing on page 7. Added symbol name "EN_VIL" to the Logic Input Low parameter and the symbold name "EN_VIH" to the Logic Input High parameter on page 7. Updated Enable section on page 14. Removed About Intersil section and updated disclaimer.
Dec 4, 2015	FN8359.7	Added a new User Guide to Related Literature section on page 1. Added EVAL2 part numbers to the ordering information table on page 3. Added Table 2 on page 4.
Nov 10, 2015	FN8359.6	Added 5x5mmWFQFN information throughout datasheet. Updated Note 1 on page 4 from "Add "-T*" suffix for tape and reel." to "Add "-T" suffix for 6k unit or "-T7A" suffix for 250 unit tape and reel options." In "PWM Control Scheme" on page 13 (last sentence) corrected a typo by changing "1.6V to "2.5V". Table 1 on page 2: Updated L1 row. Updated the "PCB Layout Recommendation" section on page 17. Added POD L16.5x5D.
Apr 23, 2015	FN8359.5	Updated the 4th Features bullet page 1 by changing value from "0.8%" to "-1.2%/1%".
Apr 23, 2014	FN8359.4	Updated electrical table, changed Phase minimum on-time MAX from 133ns to 100ns on page 7 Updated electrical table, modified test conditions for Error Amplifier trans-conductance and Power-good Output Low Voltage on page 7 Removed references to VOUT = 0.8V, and 0.9V Added typical curve for Phase minimum on-time vs VIN on page 9 Added description on synchronized control on page 14
Feb 24, 2014	FN8359.3	Updated ESD rating qual references from Jedec standard references to AEC-Q100 standard references on page 6
Dec 13, 2013	FN8359.2	Last Features bullet on page 1: changed from "Qualified for automotive application" to "AEC-Q100 qualified"
Oct16, 2013	FN8359.1	Initial Release.



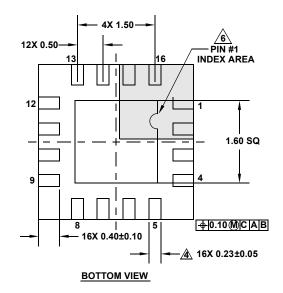
Package Outline Drawings

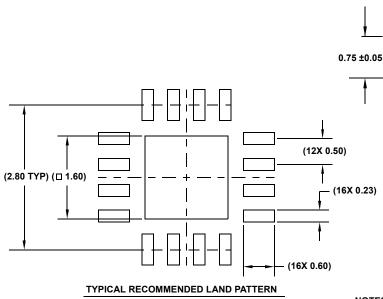
L16.3x3D

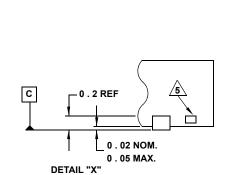
16 LEAD THIN QUAD FLAT NO-LEAD PLASTIC PACKAGE Rev 0, 3/10



For the most recent package outline drawing, see <u>L16.3x3D</u>.







- NOTES:
 - Dimensions are in millimeters.
 Dimensions in () for Reference Only.

SIDE VIEW

- 2. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
- 3. Unless otherwise specified, tolerance : Decimal \pm 0.05
- Dimension applies to the metallized terminal and is measured between 0.15mm and 0.25mm from the terminal tip.
- <u>√5</u>. Tiebar shown (if present) is a non-functional feature.
- The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.
- 7. JEDEC reference drawing: MO-220 WEED.

SEE DETAIL "X"

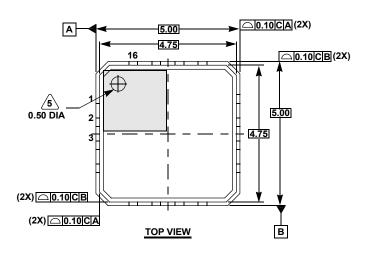
◯ 0.08 C

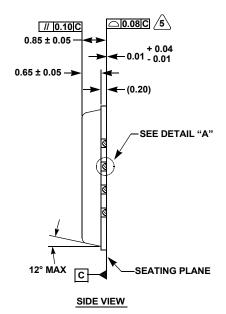
// 0.10 C

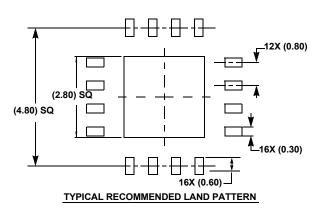
L16.5x5D

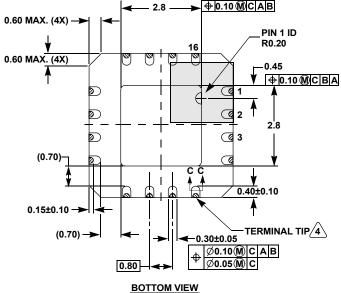
For the most recent package outline drawing, see <u>L16.5x5D</u>.

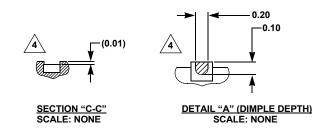
16 LEAD QUAD FLAT NO-LEAD PLASTIC PACKAGE (PUNCH QFN WITH WETTABLE FLANK) Rev 2, 5/14











NOTES:

- 1. Dimensions are in millimeters. Dimensions in () are for Reference Only.
- 2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
- Unless otherwise specified, tolerance: Decimal ± 0.05
- Dimension applies to the plated terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
- The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.
- 6. Reference document: JEDEC M0220.

Notice

- Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products
 and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your
 product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of
 these circuits, software, or information.
- 2. Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other claims involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawings, charts, programs, algorithms, and application examples.
- 3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
- 4. You shall not alter, modify, copy, or reverse engineer any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copying or reverse engineering.
- 5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
 - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; industrial robots; etc.
 - "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc.

Unless expressly designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not intended or authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems; surgical implantations; etc.), or may cause serious property damage (space system; undersea repeaters; nuclear power control systems; aircraft control systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or any third parties arising from the use of any Renesas Electronics product that is inconsistent with any Renesas Electronics data sheet, user's manual or other Renesas Electronics document.

- 6. When using Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat dissipation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions, failure or accident arising out of the use of Renesas Electronics products outside of such specified ranges.
- 7. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics, such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Unless designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not subject to radiation resistance design. You are responsible for implementing safety measures to guard against the possibility of bodily injury, injury or damage caused by fire, and/or danger to the public in the event of a failure or malfunction of Renesas Electronics products, such as safety design for hardware and software, including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult and impractical, you are responsible for evaluating the safety of the final products or systems manufactured by you.
- 8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. You are responsible for carefully and sufficiently investigating applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive, and using Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- 9. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall comply with any applicable export control laws and regulations promulgated and administered by the governments of any countries asserting jurisdiction over the parties or transactions.
- 10. It is the responsibility of the buyer or distributor of Renesas Electronics products, or any other party who distributes, disposes of, or otherwise sells or transfers the product to a third party, to notify such third party in advance of the contents and conditions set forth in this document.
- 11. This document shall not be reprinted, reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
- 12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products.
- (Note1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its directly or indirectly controlled subsidiaries.
- (Note2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Rev.4.0-1 November 2017)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit: www.renesas.com/contact/

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Renesas Electronics:

ISL78233EVAL2Z ISL78234EVAL2Z ISL78233EVAL1Z ISL78234EVAL1Z